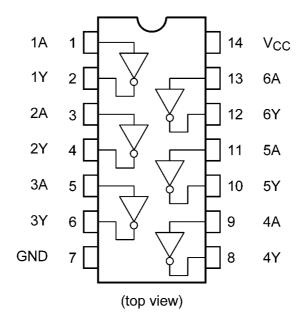
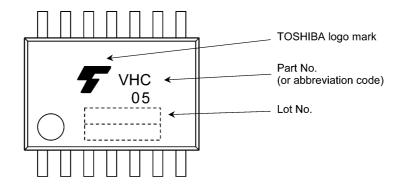


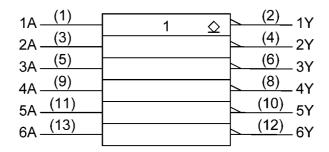
5. Pin Assignment



6. Marking



7. IEC Logic Symbol

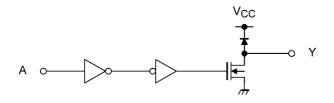




8. Truth Table

А	Y
L	Z
Н	L

9. System Diagram(per gate)



10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to 7.0	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		-20	mA
Output diode current	lok		±20	mA
Output current	l _{out}		25	mA
V _{CC} /ground current	I _{CC}		±50	mA
Power dissipation	P _D	(Note 1)	180	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}		2.0 to 5.5	V
Input voltage	V _{IN}		0 to 5.5	V
Output voltage	V _{OUT}		0 to V _{CC}	V
Operating temperature	T _{opr}		-40 to 125	°C
Input rise and fall times	dt/dv	$V_{CC} = 3.3 \pm 0.3 \text{ V}$	0 to 100	ns/V
		$V_{CC} = 5 \pm 0.5 \text{ V}$	0 to 20	

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	_	
Low-level input voltage	V _{IL}	_		2.0	_	_	0.50	V
				3.0 to 5.5	_	_	$V_{CC} \times 0.3$	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH}	I _{OL} = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I _{OL} = 4 mA	3.0	_	_	0.36	
			I _{OL} = 8 mA	4.5	_	_	0.36	
Output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IL}$ $V_{OUT} = V_{CC}$ or GND		5.5	_	_	±0.25	μА
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	_	±0.1	μΑ
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	_	2.0	μА

12.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				3.0 to 5.5	_	$V_{CC} \times 0.3$	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH}	I _{OL} = 50 μA	2.0	_	0.1	V
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.44	
			I _{OL} = 8 mA	4.5	_	0.44	
Output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IL}$ $V_{OUT} = V_{CC}$ or GND		5.5	_	±2.50	μА
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	±1.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		5.5	_	20.0	μΑ

12.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition	on	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	٧
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	٧
				3.0 to 5.5		$V_{CC} \times 0.3$	
Low-level output voltage	V _{OL}	$V_{IN} = V_{IH}$	I _{OL} = 50 μA	2.0		0.1	V
				3.0		0.1	
				4.5		0.1	
			$I_{OL} = 4 \text{ mA}$	3.0	_	0.55	
			I_{OL} = 8 mA	4.5	_	0.55	
Output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IL}$ $V_{OUT} = V_{CC}$ or GND	·	5.5	_	±10.0	μА
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	±2.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND	·	5.5	_	40.0	μΑ



12.4. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit
Propagation delay time	t _{PZL}		$R_L = 1 k\Omega$	3.3 ± 0.3	15	_	5.0	7.1	ns
					50	_	7.5	10.6	
				5.0 ± 0.5	15	_	3.8	5.5	
					50	_	5.3	7.5	
Propagation delay time	t_{PLZ}		$R_L = 1 k\Omega$	3.3 ± 0.3	50	_	7.5	10.6	ns
				5.0 ± 0.5	50	_	5.3	7.5	
Input capacitance	C _{IN}		_			_	4	10	pF
Output capacitance	C _{OUT}		_			_	5		pF
Power dissipation capacitance	C_PD	(Note 1)	_			_	6	_	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/6 \text{ (per gate)}$

12.5. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PZL}	$R_L = 1 k\Omega$	3.3 ± 0.3	15	1.0	8.5	ns
				50	1.0	12.0	
			5.0 ± 0.5	15	1.0	6.5	
				50	1.0	8.5	
Propagation delay time	t _{PLZ}	$R_L = 1 k\Omega$	3.3 ± 0.3	50	1.0	12.0	ns
			5.0 ± 0.5	50	1.0	8.5	
Input capacitance	C _{IN}	_			_	10	pF

12.6. AC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 3 ns)

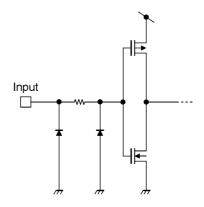
Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PZL}	$R_L = 1 k\Omega$	3.3 ± 0.3	15	1.0	10.0	ns
				50	1.0	13.5	
			5.0 ± 0.5	15	1.0	7.5	
				50	1.0	9.5	
Propagation delay time	t _{PLZ}	R _L = 1 kΩ	3.3 ± 0.3	50	1.0	13.5	ns
			5.0 ± 0.5	50	1.0	9.5	
Input capacitance	C _{IN}	_				10	pF

12.7. Noise Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-0.4	-0.8	V
Minimum high-level dynamic input voltage	V_{IHD}	C _L = 50 pF	5.0	_	3.5	V
Maximum low-level dynamic input voltage	V_{ILD}	C _L = 50 pF	5.0	_	1.5	V

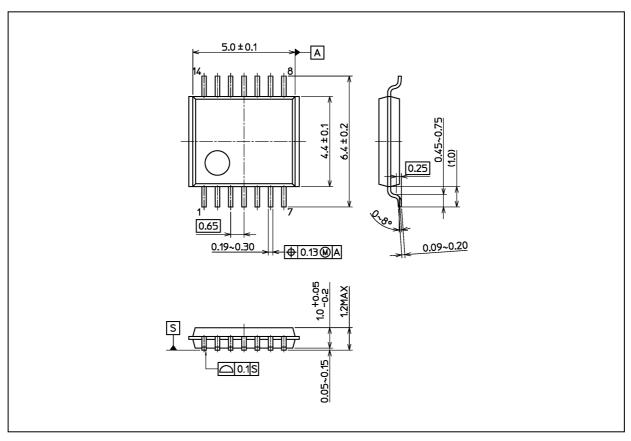


12.8. Input Equivalent Circuit



Package Dimensions

Unit: mm



Weight: 0.054 g (typ.)

Package Name(s)
Nickname: TSSOP14B



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